

### **REMARKS/ARGUMENTS**

The Office Action has been carefully considered. It is respectfully submitted that the issues raised are traversed, being hereinafter addressed with reference to the relevant headings appearing in the Detailed Action section of the Office Action.

The Applicant has amended claims. The Applicant respectfully submits that the amendments to the claim set are fully supported by the originally filed specification.

#### ***Claim Rejections – 35 USC § 112***

On page 2 of the Office Action, the Examiner has rejected claim 19 as being incomplete for omitting essential structural cooperative relationships. We have amended claim 19 to specify that the grooves or recesses are separated by a portion of the wafer which has not been etched. We respectfully request the rejection to be withdrawn.

#### ***Double Patenting***

On pages 3 and 4 of the Office Action, the Examiner has rejected claims 1, 3 and 5 to 17 on the grounds of a nonstatutory type double patenting rejection. In view of this, we are filing herewith a terminal disclaimer to overcome the double patenting objection.

#### ***Drawings***

The feature has been removed from claim 19.

**CONCLUSION**

In view of the foregoing, it is respectfully requested that the Examiner reconsider and withdraw the rejection under 35 USC § 112. The present application is believed to be in condition for allowance. Accordingly, the Applicant respectfully requests a Notice of Allowance of all the claims presently under examination.

Very respectfully,

Applicant:



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